UNIVERSIDAD POLITÉCNICA DE MADRID
ESCUELA TÉCNICA SUPERIOR DE
INGENIERÍA Y SISTEMAS DE TELECOMUNICACIÓN
Campus Sur UPM
C/ Nikola Tesla, s/n. 28031 Madrid

ADMISSION TO INTERNATIONAL DOUBLE MASTER PROGRAMMES ACADEMIC YEAR 2025/26

The ETSIST has currently in force the following international double Master degree agreements:

- **Master in Internet of Things (MIoT)**:
  - With Politecnico di Torino (Italy): agreement + addendum
  - With Technische Hochschule Köln (Germany): agreement
- **Master in Wireless Communications (MWC)**:
  - With Tongji University (China): agreement
  - With Technische Hochschule Köln (Germany): agreement

Students enrolled in either of these two Master programmes during the academic year 2025/26 may apply for admission to one of the aforementioned double degree programmes by e-mail, attaching the following **documentation**:

1. Letter of motivation
2. Accreditation of the language level required in the corresponding double degree agreement.

Applications should be sent from the @alumnos.upm.es email accounts to the following addresses:

- for MIoT → master.iot@upm.es
- for MWC → master.wireless@upm.es

The **deadline** for applications for the academic year 2025/26 is 30 December 2025. Students willing to apply for Erasmus+ or other funds for international mobility will need to submit an independent application to the corresponding call.

In case not all places foreseen in the agreements are assigned, an extraordinary application period will be opened until 31 March 2026, except for Tongji University. Students applying in the extraordinary period will not be eligible for Erasmus+ funding for their mobility periods.

Applications will be assessed according to the criteria set out in each agreement.

Rubén Fraile Muñoz
SUBDIRECTOR DE RELACIONES EXTERNAS